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Manufactured Components**

Rochester branded components are manufactured using either die/wafers purchased from the original suppliers or Rochester wafers recreated from the original IP. All recreations are done with the approval of the OCM.

Parts are tested using original factory test programs or Rochester developed test solutions to guarantee product meets or exceed the OCM data sheet.

Quality Overview

- ISO-9001
- AS9120 certification
- Qualified Manufacturers List (QML) MIL-PRF-35835
 - Class Q Military
 - Class V Space Level
- Qualified Suppliers List of Distributors (QSLD)
 - Rochester is a critical supplier to DLA and meets all industry and DLA standards.

Rochester Electronics, LLC is committed to supplying products that satisfy customer expectations for quality and are equal to those originally supplied by industry manufacturers.

The original manufacturer's datasheet accompanying this document reflects the performance and specifications of the Rochester manufactured version of this device. Rochester Electronics guarantees the performance of its semiconductor products to the original OEM specifications. 'Typical' values are for reference purposes only. Certain minimum or maximum ratings may be based on product characterization, design, simulation, or sample testing.



8-Channel/Dual 4-Channel, Low-Leakage, CMOS Analog Multiplexers

MAX338/MAX339

General Description

The MAX338/MAX339 are monolithic, CMOS analog multiplexers (muxes). The 8-channel MAX338 is designed to connect one of eight inputs to a common output by control of a 3-bit binary address. The dual, 4-channel MAX339 is designed to connect one of four inputs to a common output by control of a 2-bit binary address. Both devices can be used as either a mux or a demux. On-resistance is 400Ω max, and the devices conduct current equally well in both directions.

These muxes feature extremely low off leakages (less than 20pA at +25°C), and extremely low on-channel leakages (less than 50pA at +25°C). The new design offers guaranteed low charge injection (1.5pC typ) and electrostatic discharge (ESD) protection greater than 2000V, per method 3015.7. These improved muxes are pin-compatible upgrades for the industry-standard DG508A and DG509A. For similar Maxim devices with lower leakage and charge injection but higher on-resistance, see the MAX328 and MAX329.

The MAX338/MAX339 operate from a single +4.5V to +30V supply or from dual supplies of ±4.5V to ±20V. All control inputs (whether address or enable) are TTL compatible (+0.8V to +2.4V) over the full specified temperature range and over the ±4.5V to ±18V supply range. These parts are fabricated with Maxim's 44V silicon-gate process.

Applications

- | | |
|------------------------------|--------------------------|
| Data-Acquisition Systems | Sample-and-Hold Circuits |
| Test Equipment | Heads-Up Displays |
| Military Radios | Communications Systems |
| Guidance and Control Systems | PBX, PABX |

Features

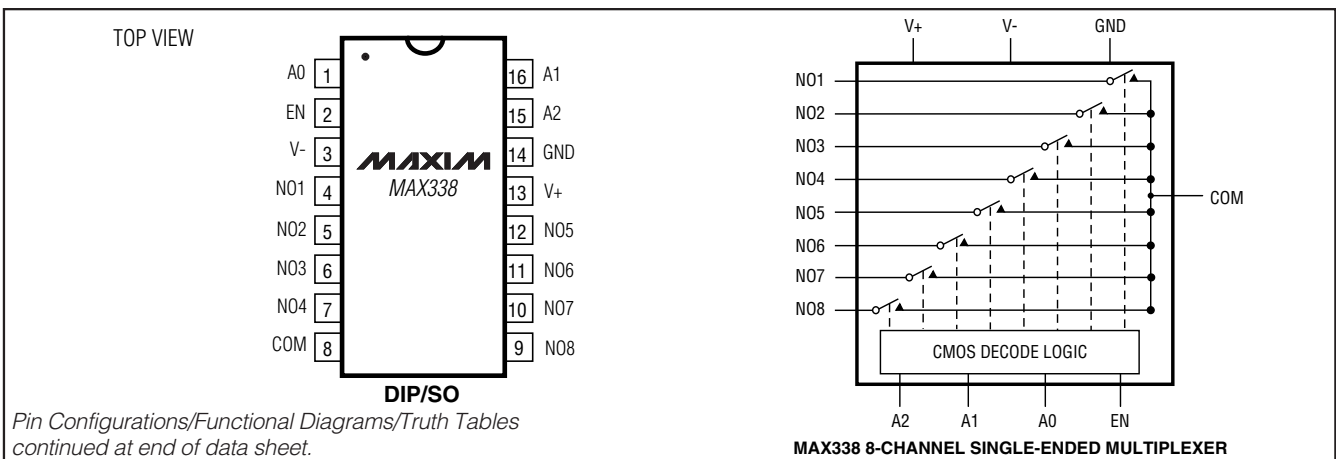
- ◆ On-Resistance, <400Ω max
- ◆ Transition Time, <500ns
- ◆ On-Resistance Match, <10Ω
- ◆ NO-Off Leakage Current, <20pA at +25°C
- ◆ 1.5pC Charge Injection
- ◆ Single-Supply Operation (+4.5V to +30V)
Bipolar-Supply Operation (±4.5V to ±20V)
- ◆ Plug-In Upgrade for Industry-Standard DG508A/DG509A
- ◆ Rail-to-Rail Signal Handling
- ◆ TTL/CMOS-Logic Compatible
- ◆ ESD Protection >2000V, per Method 3015.7

Ordering Information

PART	TEMP RANGE	PIN-PACKAGE
MAX338CPE	0°C to +70°C	16 Plastic DIP
MAX338CSE	0°C to +70°C	16 Narrow SO
MAX338C/D	0°C to +70°C	Dice*
MAX338ETE	-40°C to +85°C	16 Thin QFN (5mm x 5mm)
MAX338EPE	-40°C to +85°C	16 Plastic DIP
MAX338ESE	-40°C to +85°C	16 Narrow SO
MAX338EJE	-40°C to +85°C	16 CERDIP
MAX338MJE	-55°C to +125°C	16 CERDIP**

Ordering Information continued at end of data sheet.
 *Contact factory for dice specifications.
 **Contact factory for availability.

Pin Configurations/Functional Diagrams/Truth Tables



For pricing, delivery, and ordering information, please contact Maxim/Dallas Direct! at 1-888-629-4642, or visit Maxim's website at www.maxim-ic.com.

8-Channel/Dual 4-Channel, Low-Leakage, CMOS Analog Multiplexers

ABSOLUTE MAXIMUM RATINGS

Voltage Referenced to V-

V+-0.3V, 44V

GND-0.3V, 25V

Digital Inputs, NO, COM (Note 1).....(V- - 2V) to (V+ + 2V) or
30mA (whichever occurs first)

Continuous Current (any terminal)30mA

Peak Current, NO or COM

(pulsed at 1ms, 10% duty cycle max)100mA

Continuous Power Dissipation (TA = +70°C)

Plastic DIP (derate 10.53mW/°C above +70°C)842mW

Narrow SO (derate 8.70mW/°C above +70°C)696mW

16-Pin TQFN (derate 21.3mW/°C above +70°C)1702mW

CERDIP (derate 10.00mW/°C above +70°C)800mW

Operating Temperature Ranges

MAX33_C_0°C to +70°C

MAX33_E_-40°C to +85°C

MAX33_MJE-55°C to +125°C

Storage Temperature Range-65°C to +150°C

Lead Temperature (soldering, 10sec)+300°C

Note 1: Signals on NO, COM, EN, A0, A1, or A2 exceeding V+ or V- are clamped by internal diodes. Limit forward current to maximum current ratings.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

ELECTRICAL CHARACTERISTICS—Dual Supplies

(V+ = +15V, V- = -15V, GND = 0V, VAH = +2.4V, VAL = +0.8V, TA = TMIN to TMAX, unless otherwise noted.)

PARAMETER	SYMBOL	CONDITIONS		MIN	TYP (Note 2)	MAX	UNITS	
SWITCH								
Analog Signal Range	VNO, VCOM	(Note 3)		-15		15	V	
On-Resistance	RON	INO = 0.2mA, VCOM = ±10V	TA = +25°C		220	400	Ω	
			TA = TMIN to TMAX			500		
On-Resistance Matching Between Channels	ΔRON	INO = 0.2mA, VCOM = ±10V (Note 4)	TA = +25°C		4	10	Ω	
			TA = TMIN to TMAX			15		
NO-Off Leakage Current (Note 5)	INO(OFF)	VCOM = ±10V, VNO = ±10V, VEN = 0V	TA = +25°C	-0.02	0.001	0.02	nA	
			TA = TMIN to TMAX	-1.25	0.001	1.25		
								C, E
							M	20
COM-Off Leakage Current (Note 5)	ICOM(OFF)	VNO = ±10V, VCOM = ±10V, VEN = 0V	MAX338	TA = +25°C	-0.05	0.005	0.05	nA
				TA = TMIN to TMAX	-3.25	0.005	3.25	
				C, E				
				M	-40	40		
		VNO = ±10V, VCOM = ±10V, VEN = 0V	MAX339	TA = +25°C	-0.05	0.005	0.05	
				TA = TMIN to TMAX	-1.65	0.005	1.65	
				C, E				1.65
							M	20
COM-On Leakage Current (Note 5)	ICOM(ON)	VCOM = ±10V, VNO = ±10V, sequence each switch on	MAX338	TA = +25°C	-0.05	0.006	0.05	nA
				TA = TMIN to TMAX	-3.25	0.006	3.25	
				C, E				
				M	-40	40		
		VCOM = ±10V, VNO = ±10V, sequence each switch on	MAX339	TA = +25°C	-0.05	0.008	0.05	
				TA = TMIN to TMAX	-1.65	0.008	1.65	
				C, E				1.65
							M	20

8-Channel/Dual 4-Channel, Low-Leakage, CMOS Analog Multiplexers

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ELECTRICAL CHARACTERISTICS—Dual Supplies (continued)

(V+ = +15V, V- = -15V, GND = 0V, VAH = +2.4V, VAL = +0.8V, TA = TMIN to TMAX, unless otherwise noted.)

PARAMETER	SYMBOL	CONDITIONS		MIN	TYP (Note 2)	MAX	UNITS
INPUT							
Input Current with Input Voltage High	IAH	VA = 2.4V or 15V		-1.0	0.001	1.0	μA
Input Current with Input Voltage Low	I _{AL}	VEN = 0V or 2.4V, VA = 0V		-1.0		1.0	μA
SUPPLY							
Power-Supply Range				±4.5		±20	V
Positive Supply Current	I+	VEN = VA = 0V	TA = +25°C		50	100	μA
			TA = TMIN to TMAX			150	
		VEN = 2.4V, VA(ALL) = 2.4V	TA = +25°C		290	500	μA
			TA = TMIN to TMAX			600	
Negative Supply Current	I-	VEN = 0V or 2.4V, VA(ALL) = 0V, 2.4V or 5V	TA = +25°C		-1	1	μA
			TA = TMIN to TMAX			-10	
DYNAMIC							
Transition Time	tTRANS	Figure 2	TA = +25°C		200	500	ns
Break-Before-Make Interval	tOPEN	Figure 4	TA = +25°C	10	140		ns
Enable Turn-On Time	tON(EN)	Figure 3	TA = +25°C		160	500	ns
			TA = TMIN to TMAX			750	
Enable Turn-Off Time	tOFF(EN)	Figure 3	TA = +25°C		100	500	ns
			TA = TMIN to TMAX			750	
Charge Injection (Note 3)	Q	CL = 100pF, VNO = 0V, RS = 0Ω, Figure 6	TA = +25°C		1.5	5	pC
Off Isolation (Note 6)	VISO	VEN = 0V, RL = 1kΩ, f = 100kHz	TA = +25°C		-75		dB
Crosstalk Between Channels	VCT	VEN = 2.4V, f = 100kHz, VGEN = 1VP-P, RL = 1kΩ, Figure 7	TA = +25°C		-92		dB
Logic Input Capacitance	CIN	f = 1MHz	TA = +25°C		2		pF
NO-Off Capacitance	CNO(OFF)	f = 1MHz, VEN = VNO = 0V, Figure 8	TA = +25°C		3		pF
COM-Off Capacitance	CCOM(OFF)	f = 1MHz, VEN = 0.8V, VCOM = 0V, Figure 8	MAX338	TA = +25°C	11		pF
			MAX339		6		
COM-On Capacitance	CCOM(ON)	f = 1MHz, VEN = 2.4V, VCOM = 0V, Figure 8	MAX338	TA = +25°C	16		pF
			MAX339		9		

8-Channel/Dual 4-Channel, Low-Leakage, CMOS Analog Multiplexers

ELECTRICAL CHARACTERISTICS—Single Supply

(V+ = +12V, V- = 0V, GND = 0V, V_{AH} = +2.4V, V_{AL} = +0.8V, T_A = T_{MIN} to T_{MAX}, unless otherwise noted.)

PARAMETER	SYMBOL	CONDITIONS		MIN	TYP (Note 2)	MAX	UNITS
SWITCH							
Analog Signal Range	V _{NO} , V _{COM}	(Note 3)		0		12	V
On-Resistance	R _{ON}	I _{NO} = 0.2mA V _{COM} = 3V or 10V	T _A = +25°C		460	650	Ω
DYNAMIC							
Transition Time (Note 3)	t _{TRANS}	V _{NO1} = 8V, V _{NO8} = 0V, V _{IN} = 2.4V, Figure 1	T _A = +25°C		210	500	ns
Enable Turn-On Time (Note 3)	t _{ON(EN)}	V _{INH} = 2.4V, V _{INL} = 0V, V _{NO1} = 5V, Figure 3	T _A = +25°C		280	500	ns
Enable Turn-Off Time (Note 3)	t _{OFF(EN)}	V _{INH} = 2.4V, V _{INL} = 0V, V _{NO1} = 5V, Figure 3	T _A = +25°C		110	500	ns
Charge Injection (Note 3)	Q	C _L = 100pF, V _{NO} = 0V, R _S = 0Ω	T _A = +25°C		1.8	5	pC

Note 2: The algebraic convention where the most negative value is a minimum and the most positive value a maximum is used in this data sheet.

Note 3: Guaranteed by design.

Note 4: $\Delta R_{ON} = R_{ON(MAX)} - R_{ON(MIN)}$.

Note 5: Leakage parameters are 100% tested at the maximum rated hot temperature and guaranteed by correlation at +25°C.

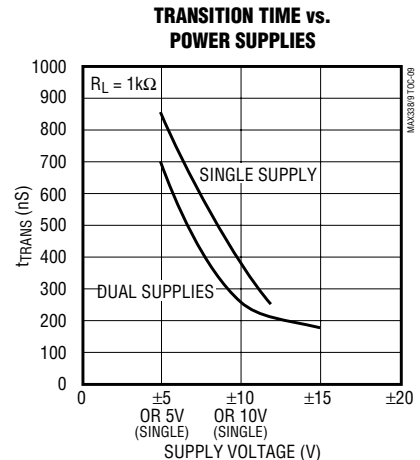
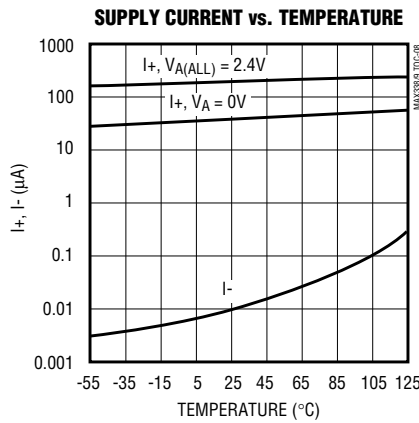
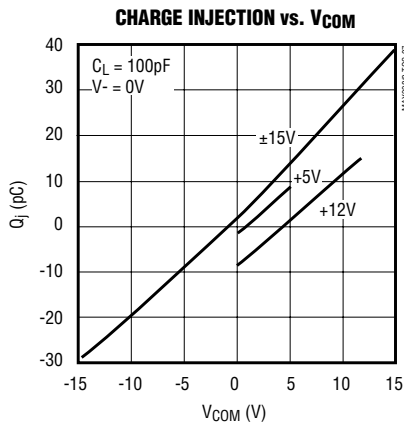
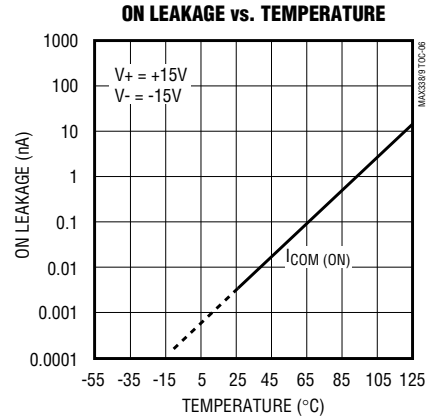
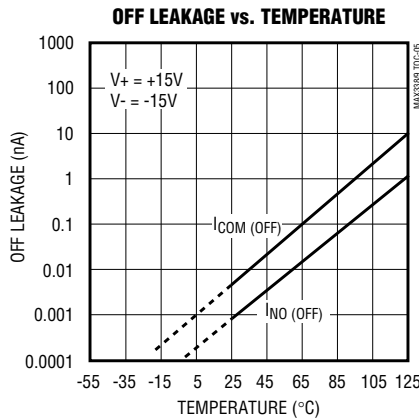
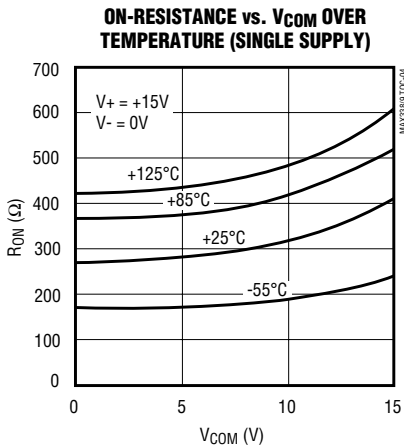
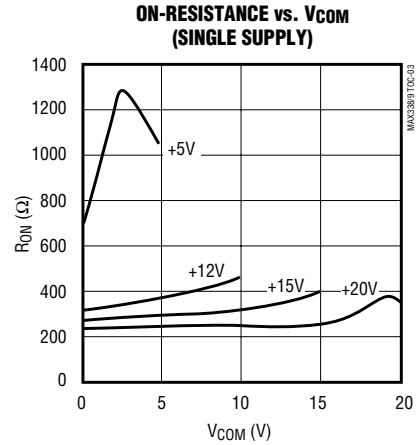
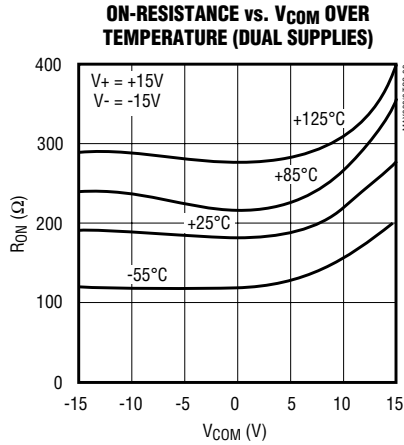
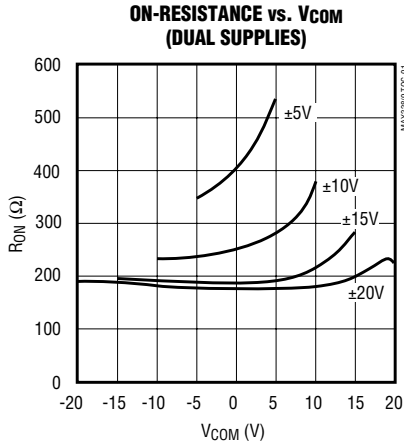
Note 6: Worst-case isolation is on channel 4 because of its proximity to the drain pin. Off isolation = $20 \log V_{COM}/V_{NO}$, where V_{COM} = output and V_{NO} = input to off switch.

8-Channel/Dual 4-Channel, Low-Leakage, CMOS Analog Multiplexers

Typical Operating Characteristics

($T_A = +25^\circ\text{C}$, unless otherwise noted.)

MAX3338/MAX3339



8-Channel/Dual 4-Channel, Low-Leakage, CMOS Analog Multiplexers

Pin Description

PIN				NAME	FUNCTION
MAX338		MAX339			
DIP/SO	THIN QFN	DIP/SO	THIN QFN		
1, 15, 16,	15, 14, 13	—	—	A0, A2, A1	Address Inputs
—	—	1, 16	15, 14	A0, A1	Address Inputs
2	16	2	16	EN	Enable
3	1	3	1	V-	Negative-Supply Voltage Input
4–7	2–5	—	—	NO1–NO14	Analog Inputs—Bidirectional
—	—	4–7	2–5	NO1A–NO4A	Analog Inputs—Bidirectional
8	6	—	—	COM	Analog Output—Bidirectional
—	—	8, 9	6, 7	COMA, COMB	Analog Outputs—Bidirectional
9–12	7–10	—	—	NO8–NO5	Analog Inputs—Bidirectional
—	—	10–3	8–11	NO4B–NO1B	Analog Inputs—Bidirectional
13	11	14	12	V+	Positive-Supply Voltage Input
14	12	15	13	GND	Ground
—	EP	—	EP	Exposed Pad	Exposed Pad. Connect to V+.

Applications Information

Operation with Supply Voltages Other than 15V

Using supply voltages less than $\pm 15\text{V}$ will reduce the analog signal range. The MAX338/MAX339 switches operate with $\pm 4.5\text{V}$ to $\pm 20\text{V}$ bipolar supplies or with a $+4.5\text{V}$ to $+30\text{V}$ single supply. Connect V- to GND when operating with a single supply. Both device types can also operate with unbalanced supplies such as $+24\text{V}$ and -5V . The *Typical Operating Characteristics* graphs show typical on-resistance with 20V, 15V, 10V, and 5V supplies. (Switching times increase by a factor of two or more for operation at 5V.)

Overvoltage Protection

Proper power-supply sequencing is recommended for all CMOS devices. Do not exceed the absolute maximum ratings, because stresses beyond the listed ratings may cause permanent damage to the devices. Always sequence V+ on first, then V-, followed by the logic inputs NO and COM. If power-supply sequencing is not possible, add two small signal diodes in series with supply pins for overvoltage protection (Figure 1). Adding diodes reduces the analog signal range to 1V below V+ and 1V above V-, but does not affect the devices' low switch resistance and low leakage characteristics. Device operation is unchanged, and the difference between V+ and V- should not exceed 44V.

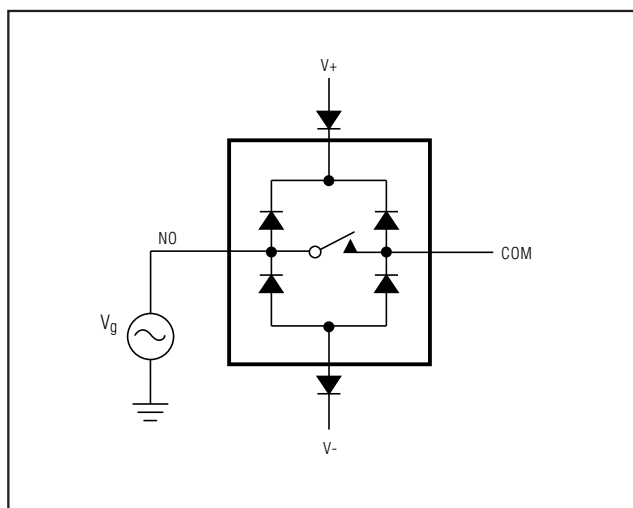


Figure 1. Overvoltage Protection Using External Blocking Diodes

8-Channel/Dual 4-Channel, Low-Leakage, CMOS Analog Multiplexers

Test Circuits/Timing Diagrams

MAX3338/MAX3339

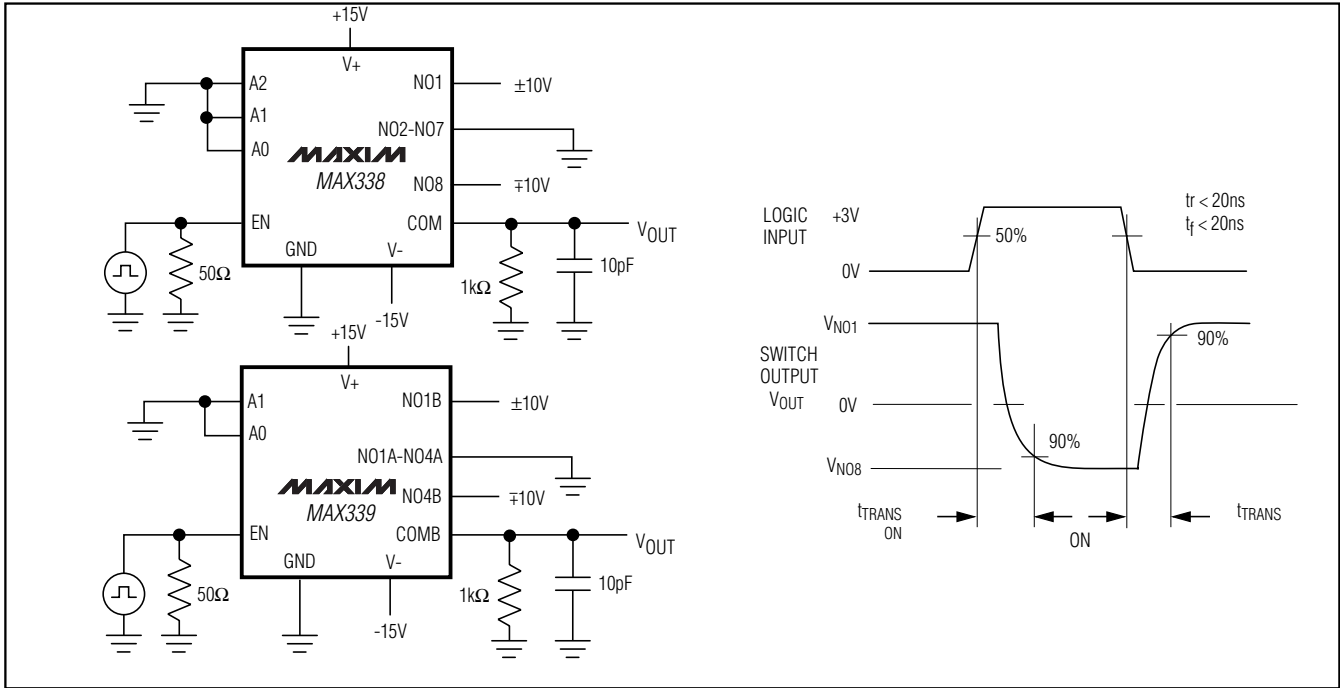


Figure 2. Transition Time

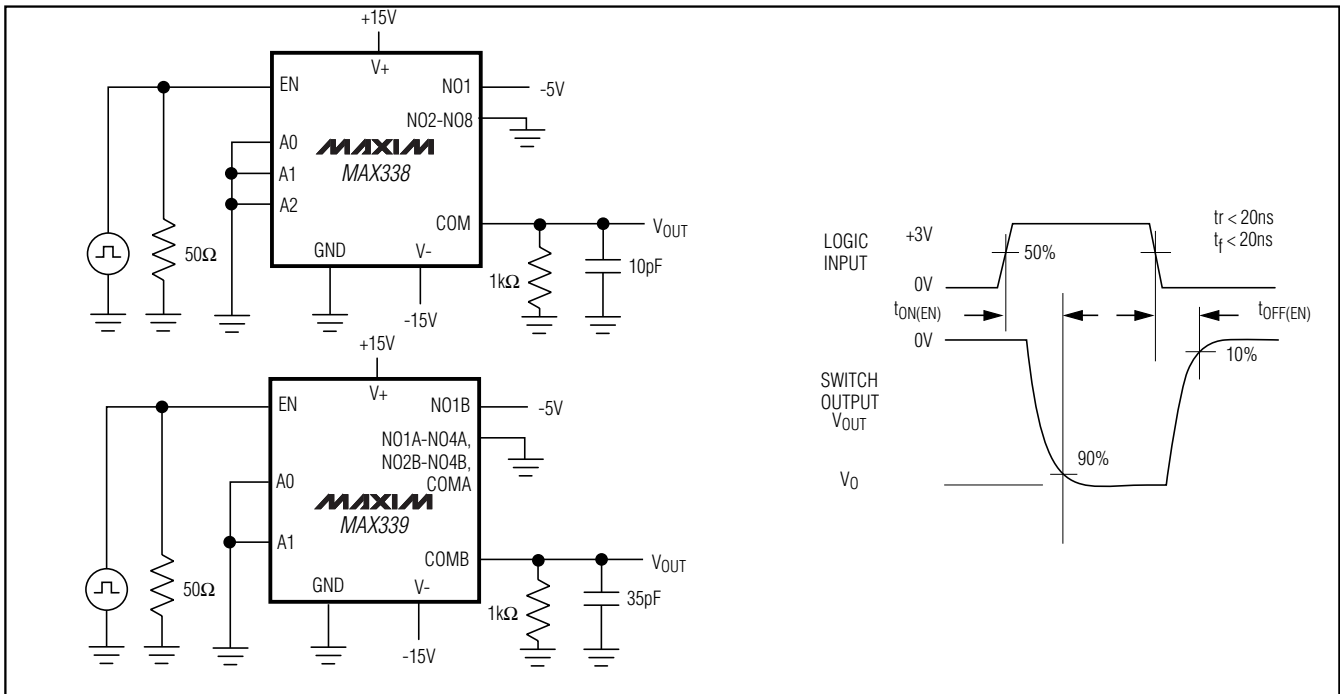


Figure 3. Enable Switching Time

8-Channel/Dual 4-Channel, Low-Leakage, CMOS Analog Multiplexers

Test Circuits/Timing Diagrams (continued)

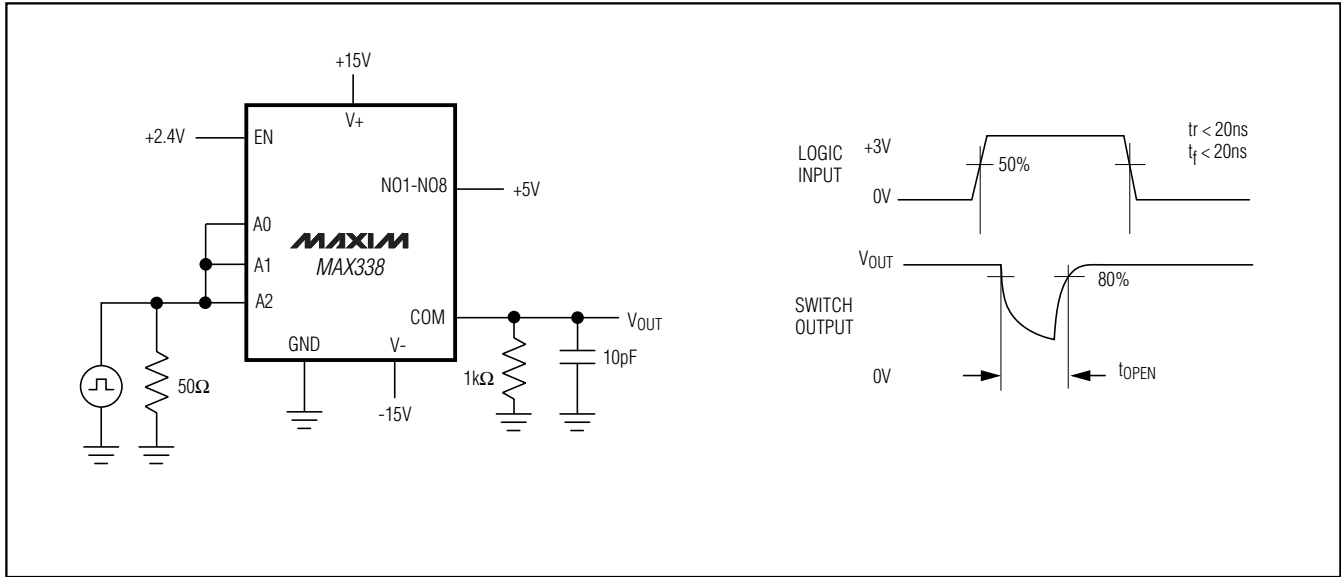


Figure 4. Break-Before-Make Interval

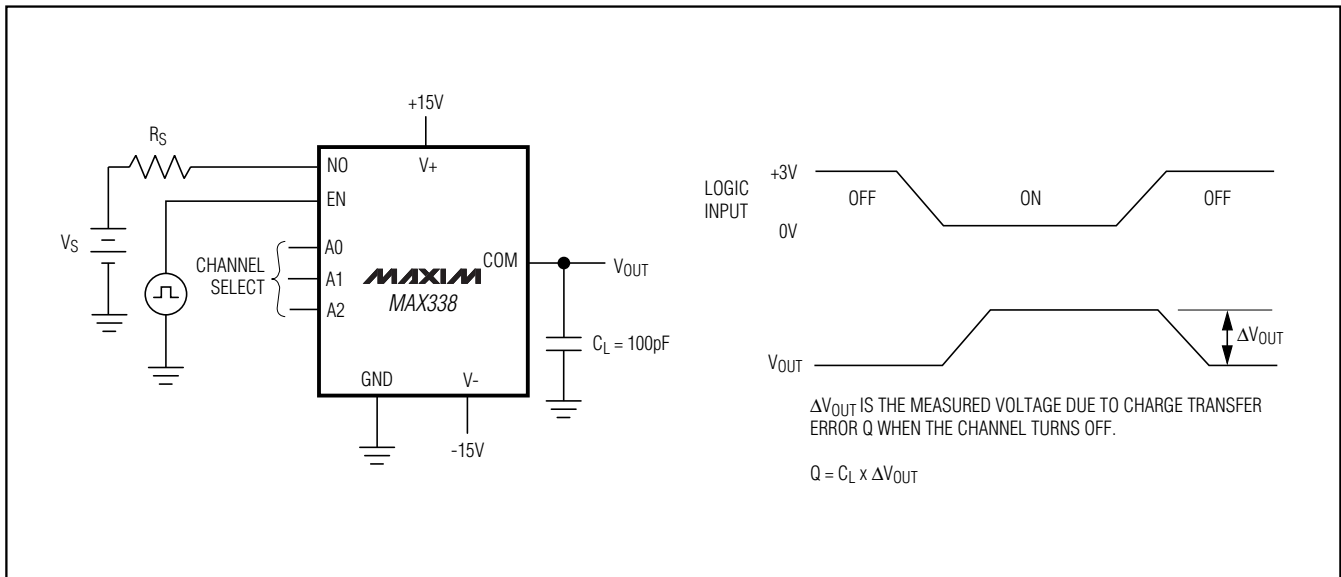


Figure 5. Charge Injection

8-Channel/Dual 4-Channel, Low-Leakage, CMOS Analog Multiplexers

Test Circuits/Timing Diagrams (continued)

MAX338/MAX339

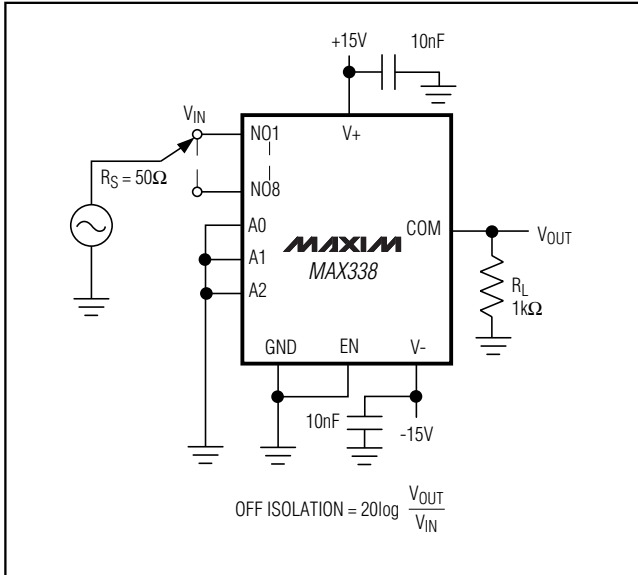


Figure 6. Off-Isolation

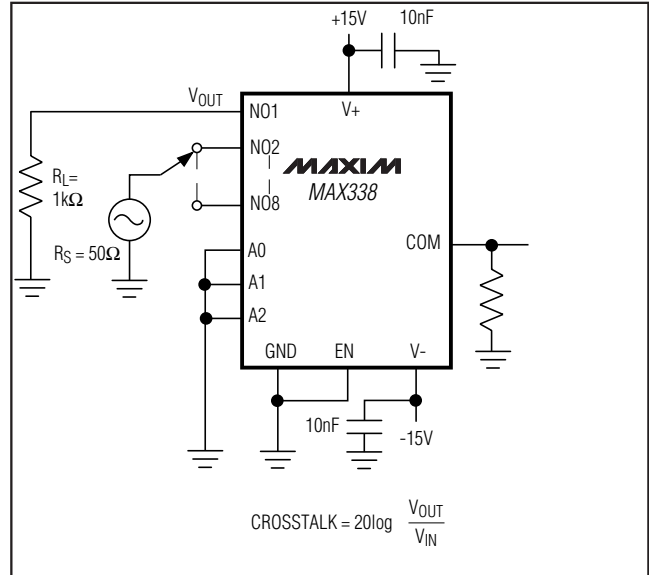


Figure 7. Crosstalk

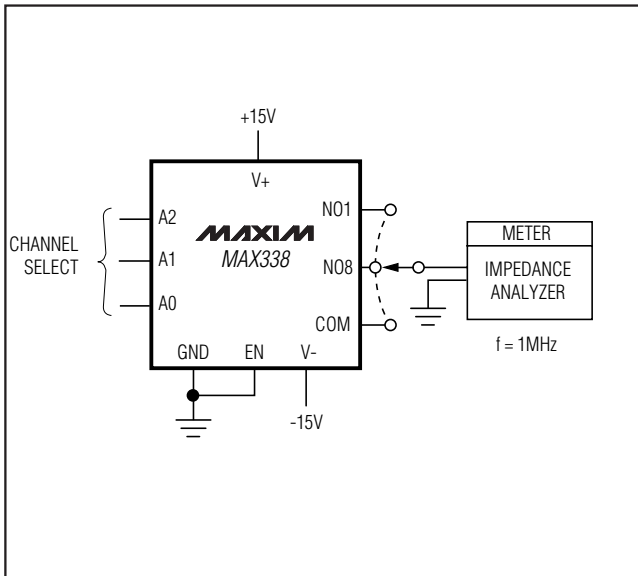
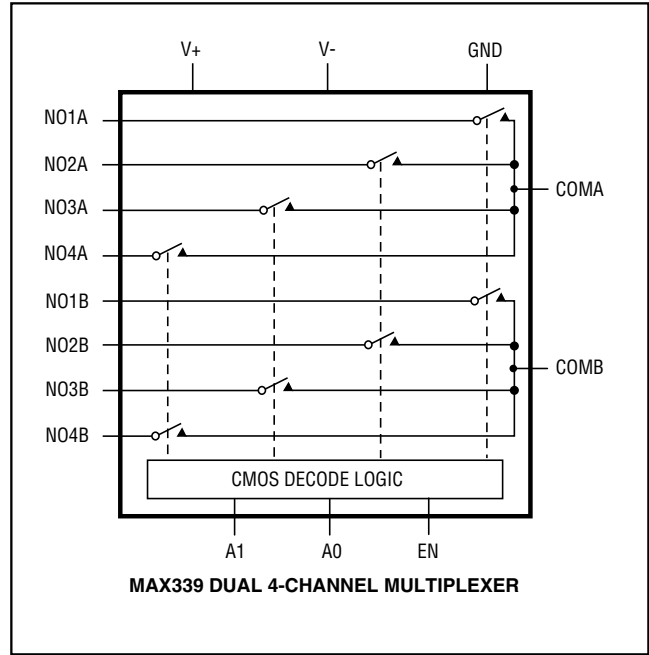
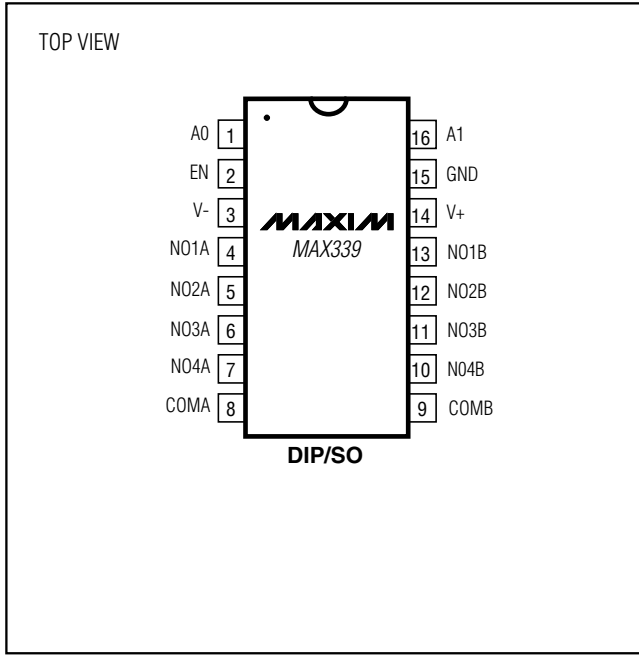


Figure 8. NO/COM Capacitance

8-Channel/Dual 4-Channel, Low-Leakage, CMOS Analog Multiplexers

Pin Configurations/Functional Diagrams/Truth Tables (continued)



A2	A1	A0	EN	ON SWITCH
X	X	X	0	None
0	0	0	1	1
0	0	1	1	2
0	1	0	1	3
0	1	1	1	4
1	0	0	1	5
1	0	1	1	6
1	1	0	1	7
1	1	1	1	8

MAX338

LOGIC "0" $V_{AL} \leq 0.8V$, LOGIC "1" $V_{AH} \geq 2.4V$

A1	A0	EN	ON SWITCH
X	X	0	None
0	0	1	1
0	1	1	2
1	0	1	3
1	1	1	4

MAX339

LOGIC "0" $V_{AL} \leq 0.8V$, LOGIC "1" $V_{AH} \geq 2.4V$

8-Channel/Dual 4-Channel, Low-Leakage, CMOS Analog Multiplexers

MAX3338/MAX3339

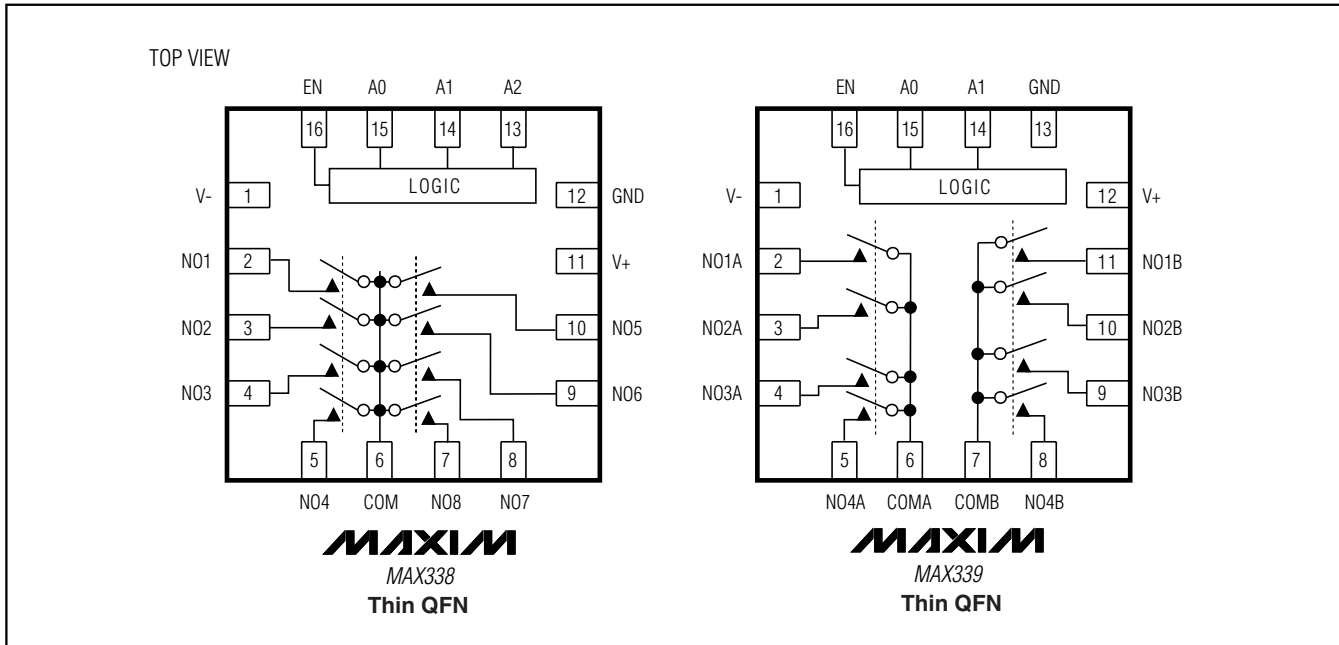
Ordering Information (continued)

PART	TEMP RANGE	PIN-PACKAGE
MAX339CPE	0°C to +70°C	16 Plastic DIP
MAX339CSE	0°C to +70°C	16 Narrow SO
MAX339C/D	0°C to +70°C	Dice*
MAX339ETE	-40°C to +85°C	16 Thin QFN (5mm x 5mm)
MAX339EPE	-40°C to +85°C	16 Plastic DIP
MAX339ESE	-40°C to +85°C	16 Narrow SO
MAX339EJE	-40°C to +85°C	16 CERDIP
MAX339MJE	-55°C to +125°C	16 CERDIP**

*Contact factory for dice specifications.

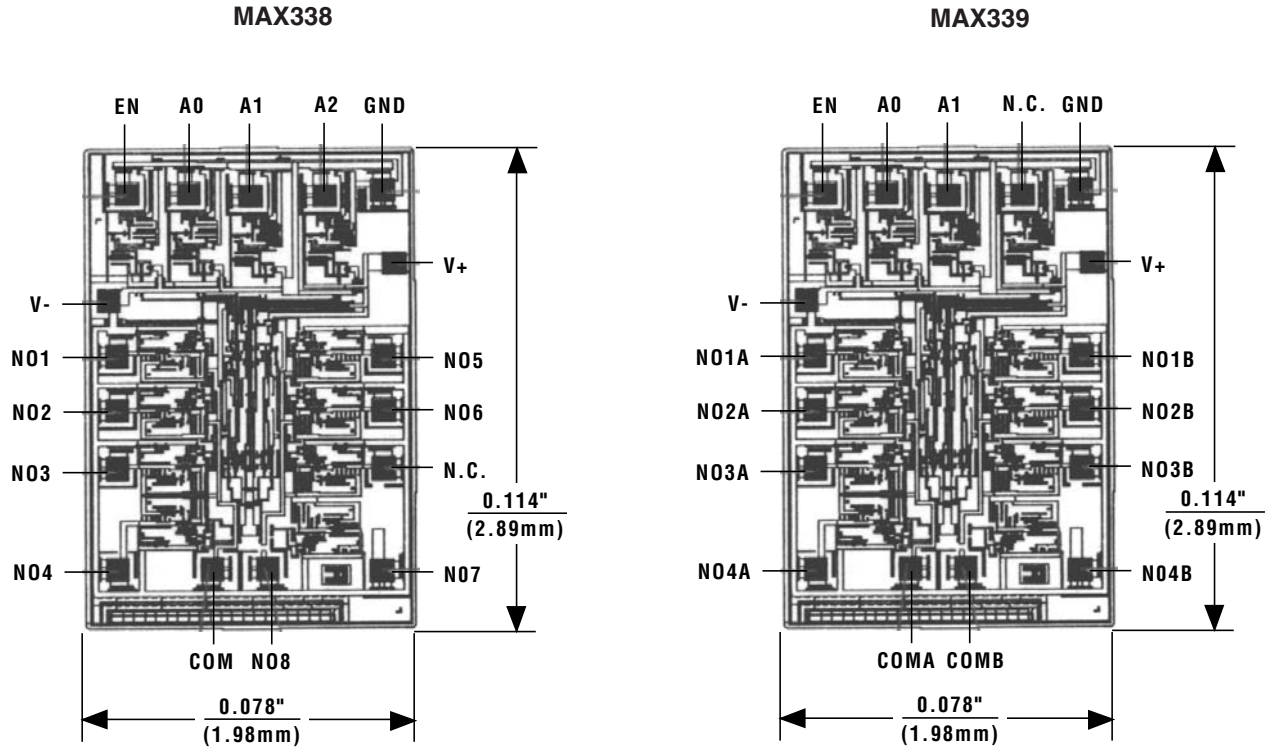
**Contact factory for availability.

Pin Configurations/Functional Diagrams/Truth Tables (continued)



8-Channel/Dual 4-Channel, Low-Leakage, CMOS Analog Multiplexers

Chip Topographies



N.C. = NO INTERNAL CONNECTION

TRANSISTOR COUNT: 224
 SUBSTRATE IS INTERNALLY CONNECTED TO V+
Note: On Thin QFN packages connect exposed pad to V+.

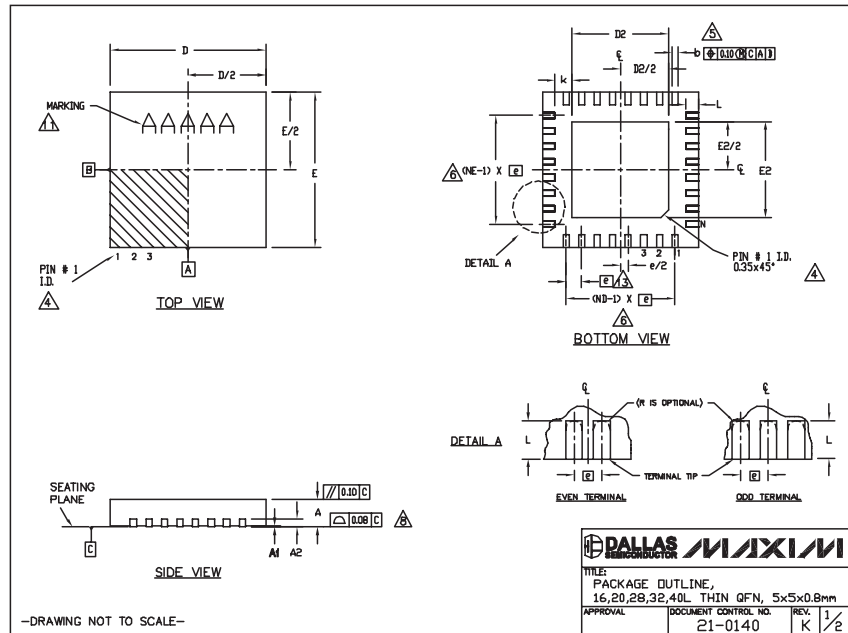
TRANSISTOR COUNT: 224
 SUBSTRATE IS INTERNALLY CONNECTED TO V+

8-Channel/Dual 4-Channel, Low-Leakage, CMOS Analog Multiplexers

Package Information

(The package drawing(s) in this data sheet may not reflect the most current specifications. For the latest package outline information, go to www.maxim-ic.com/packages.)

MAX3338/MAX3339



COMMON DIMENSIONS															
PKG SYMBOL	16L 5x5			20L 5x5			28L 5x5			32L 5x5			40L 5x5		
	MIN.	NOM.	MAX.	MIN.	NOM.	MAX.	MIN.	NOM.	MAX.	MIN.	NOM.	MAX.	MIN.	NOM.	MAX.
A	0.70	0.75	0.80	0.70	0.75	0.80	0.70	0.75	0.80	0.70	0.75	0.80	0.70	0.75	0.80
A1	0	0.02	0.05	0	0.02	0.05	0	0.02	0.05	0	0.02	0.05	0	0.02	0.05
A2	0.20 REF.			0.20 REF.			0.20 REF.			0.20 REF.			0.20 REF.		
b	0.25	0.30	0.35	0.25	0.30	0.35	0.20	0.25	0.30	0.20	0.25	0.30	0.15	0.20	0.25
D	4.90	5.00	5.10	4.90	5.00	5.10	4.90	5.00	5.10	4.90	5.00	5.10	4.90	5.00	5.10
E	4.90	5.00	5.10	4.90	5.00	5.10	4.90	5.00	5.10	4.90	5.00	5.10	4.90	5.00	5.10
e	0.80 BSC.			0.65 BSC.			0.50 BSC.			0.50 BSC.			0.40 BSC.		
k	0.25			-			0.25			-			0.25		
L	0.30	0.40	0.50	0.45	0.55	0.65	0.45	0.55	0.65	0.30	0.40	0.50	0.30	0.40	0.50
N	16			20			28			32			40		
ND	4			5			7			8			10		
NE	4			5			7			8			10		
JEDEC	VHFB			WHHC			WHHD-1			WHHD-2			-----		

EXPOSED PAD VARIATIONS											
PKG CODES	DP			EP							
	MIN.	NOM.	MAX.	MIN.	NOM.	MAX.					
T1655-2	3.00	3.10	3.20	3.00	3.10	3.20					
T1655-3	3.00	3.10	3.20	3.00	3.10	3.20					
T1655N-1	3.00	3.10	3.20	3.00	3.10	3.20					
T2055-3	3.00	3.10	3.20	3.00	3.10	3.20					
T2055-4	3.00	3.10	3.20	3.00	3.10	3.20					
T2055-5	3.15	3.25	3.35	3.15	3.25	3.35					
T2055N-5	3.15	3.25	3.35	3.15	3.25	3.35					
T2855-3	3.15	3.25	3.35	3.15	3.25	3.35					
T2855-4	2.60	2.70	2.80	2.60	2.70	2.80					
T2855-5	2.60	2.70	2.80	2.60	2.70	2.80					
T2855-6	3.15	3.25	3.35	3.15	3.25	3.35					
T2855-7	2.60	2.70	2.80	2.60	2.70	2.80					
T2855-9	3.15	3.25	3.35	3.15	3.25	3.35					
T2855N-1	3.15	3.25	3.35	3.15	3.25	3.35					
T3255-3	3.00	3.10	3.20	3.00	3.10	3.20					
T3255-4	3.00	3.10	3.20	3.00	3.10	3.20					
T3255N-4	3.00	3.10	3.20	3.00	3.10	3.20					
T3255-5	3.00	3.10	3.20	3.00	3.10	3.20					
T3255N-1	3.00	3.10	3.20	3.00	3.10	3.20					
T4055-1	3.40	3.50	3.60	3.40	3.50	3.60					
T4055-2	3.40	3.50	3.60	3.40	3.50	3.60					

NOTES:

- DIMENSIONING & TOLERANCING CONFORM TO ASME Y14.5M-1994.
- ALL DIMENSIONS ARE IN MILLIMETERS. ANGLES ARE IN DEGREES.
- N IS THE TOTAL NUMBER OF TERMINALS.
- THE TERMINAL #1 IDENTIFIER AND TERMINAL NUMBERING CONVENTION SHALL CONFORM TO JEDEC 95-1 SPP-012. DETAILS OF TERMINAL #1 IDENTIFIER ARE OPTIONAL, BUT MUST BE LOCATED WITHIN THE ZONE INDICATED. THE TERMINAL #1 IDENTIFIER MAY BE EITHER A MOLD OR MARKED FEATURE.
- DIMENSION b APPLIES TO METALLIZED TERMINAL AND IS MEASURED BETWEEN 0.25 mm AND 0.30 mm FROM TERMINAL TIP.
- ND AND NE REFER TO THE NUMBER OF TERMINALS ON EACH D AND E SIDE RESPECTIVELY.
- DEPOLARIZATION IS POSSIBLE IN A SYMMETRICAL FASHION.
- COPLANARITY APPLIES TO THE EXPOSED HEAT SINK SLUG AS WELL AS THE TERMINALS.
- DRAWING CONFORMS TO JEDEC M02B, EXCEPT EXPOSED PAD DIMENSION FOR T2855-3, T2855-6, T4055-1 AND T4055-2.
- VARPAGE SHALL NOT EXCEED 0.10 mm.
- MARKING IS FOR PACKAGE ORIENTATION REFERENCE ONLY.
- NUMBER OF LEADS SHOWN ARE FOR REFERENCE ONLY.
- LEAD CENTERLINES TO BE AT TRUE POSITION AS DEFINED BY BASIC DIMENSION 'e', #005.

-DRAWING NOT TO SCALE-

TITLE: PACKAGE OUTLINE, 16,20,28,32,40L THIN QFN, 5x5x0.8mm	
APPROVAL	DOCUMENT CONTROL NO. 21-0140
REV. 1	K 1/2

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MAX338

Part Number Table

Notes:

1. See the [MAX338 QuickView Data Sheet](#) for further information on this product family or download the [MAX338 full data sheet](#) (PDF, 256kB).
2. Other options and links for purchasing parts are listed at: <http://www.maxim-ic.com/sales>.
3. [Didn't Find What You Need?](#) Ask our applications engineers. Expert assistance in finding parts, usually within one business day.
4. Part number suffixes: T or T&R = tape and reel; + = RoHS/lead-free; # = RoHS/lead-exempt. More: See [full data sheet](#) or [Part Naming Conventions](#).
5. * Some packages have variations, listed on the drawing. "PkgCode/Variation" tells which variation the product uses.

Part Number	Free Sample	Buy Direct	Package: TYPE PINS SIZE DRAWING CODE/VAR *	Temp	RoHS/Lead-Free? Materials Analysis
MAX338EJE			Ceramic DIP;16 pin;.300" Dwg: 21-0045A (PDF) Use pkgcode/variation: J16-4*	-40C to +85C	RoHS/Lead-Free: No Materials Analysis
MAX338MJE			Ceramic DIP;16 pin;.300" Dwg: 21-0045A (PDF) Use pkgcode/variation: J16-4*	-55C to +125C	RoHS/Lead-Free: No Materials Analysis
MAX338C/D					RoHS/Lead-Free: No
MAX338CPE			PDIP;16 pin;.300" Dwg: 21-0043D (PDF) Use pkgcode/variation: P16-1*	0C to +70C	RoHS/Lead-Free: No Materials Analysis
MAX338CPE+			PDIP;16 pin;.300" Dwg: 21-0043D (PDF) Use pkgcode/variation: P16+1*	0C to +70C	RoHS/Lead-Free: Yes Materials Analysis
MAX338EPE+			PDIP;16 pin;.300" Dwg: 21-0043D (PDF) Use pkgcode/variation: P16+1*	-40C to +85C	RoHS/Lead-Free: Yes Materials Analysis
MAX338EPE			PDIP;16 pin;.300" Dwg: 21-0043D (PDF) Use pkgcode/variation: P16-1*	-40C to +85C	RoHS/Lead-Free: No Materials Analysis

MAX338EEE+			QSOP;16 pin;.150" Dwg: 21-0055F (PDF) Use pkgcode/variation: E16+6*	-40C to +85C	RoHS/Lead-Free: Yes Materials Analysis
MAX338EEE+T				-40C to +85C	RoHS/Lead-Free: Yes
MAX338CEE+T				0C to +70C	RoHS/Lead-Free: Yes
MAX338CEE+			QSOP;16 pin;.150" Dwg: 21-0055F (PDF) Use pkgcode/variation: E16+6*	0C to +70C	RoHS/Lead-Free: Yes Materials Analysis
MAX338CEE			QSOP;16 pin;.150" Dwg: 21-0055F (PDF) Use pkgcode/variation: E16-6*	0C to +70C	RoHS/Lead-Free: No Materials Analysis
MAX338CEE-T			QSOP;16 pin;.150" Dwg: 21-0055F (PDF) Use pkgcode/variation: E16-6*	0C to +70C	RoHS/Lead-Free: No Materials Analysis
MAX338EEE-T			QSOP;16 pin;.150" Dwg: 21-0055F (PDF) Use pkgcode/variation: E16-6*	-40C to +85C	RoHS/Lead-Free: No Materials Analysis
MAX338EEE			QSOP;16 pin;.150" Dwg: 21-0055F (PDF) Use pkgcode/variation: E16-6*	-40C to +85C	RoHS/Lead-Free: No Materials Analysis
MAX338CSE			SOIC;16 pin;.150" Dwg: 21-0041B (PDF) Use pkgcode/variation: S16-2*	0C to +70C	RoHS/Lead-Free: No Materials Analysis
MAX338CSE+T			SOIC;16 pin;.150" Dwg: 21-0041B (PDF) Use pkgcode/variation: S16+2*	0C to +70C	RoHS/Lead-Free: Yes Materials Analysis
MAX338CSE+			SOIC;16 pin;.150" Dwg: 21-0041B (PDF) Use pkgcode/variation: S16+2*	0C to +70C	RoHS/Lead-Free: Yes Materials Analysis
MAX338CSE-T			SOIC;16 pin;.150" Dwg: 21-0041B (PDF) Use pkgcode/variation: S16-2*	0C to +70C	RoHS/Lead-Free: No Materials Analysis
MAX338ESE+T			SOIC;16 pin;.150" Dwg: 21-0041B (PDF) Use pkgcode/variation: S16+2*	-40C to +85C	RoHS/Lead-Free: Yes Materials Analysis
MAX338ESE+			SOIC;16 pin;.150" Dwg: 21-0041B (PDF) Use pkgcode/variation: S16+2*	-40C to +85C	RoHS/Lead-Free: Yes Materials Analysis
MAX338ESE-T			SOIC;16 pin;.150" Dwg: 21-0041B (PDF) Use pkgcode/variation: S16-2*	-40C to +85C	RoHS/Lead-Free: No Materials Analysis
MAX338ESE			SOIC;16 pin;.150" Dwg: 21-0041B (PDF) Use pkgcode/variation: S16-2*	-40C to +85C	RoHS/Lead-Free: No Materials Analysis

MAX338ETE			THIN QFN;16 pin;5x5x0.8mm Dwg: 21-0140K (PDF) Use pkgcode/variation: T1655-2*	-40C to +85C	RoHS/Lead-Free: No Materials Analysis
MAX338ETE-T				-40C to +85C	RoHS/Lead-Free: No
MAX338ETE+			THIN QFN;16 pin;5x5x0.8mm Dwg: 21-0140K (PDF) Use pkgcode/variation: T1655+2*	-40C to +85C	RoHS/Lead-Free: Yes Materials Analysis
MAX338ETE+T				-40C to +85C	RoHS/Lead-Free: Yes

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